



40V PNP HIGH GAIN TRANSISTOR POWERDI®

Features

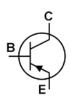
- $BV_{CEO} > -40V$
- I_C = -3A high Continuous Collector Current
- I_{CM} = -6A Peak Pulse Current
- 43% smaller than SOT223; 60% smaller than TO252
- Maximum Height Just 1.1mm
- Rated up to 3.2W
- Low Saturation, High Gain Transistor,
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

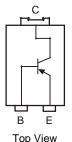
- Case: POWERDI5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.093 grams (approximate)











Pin Out

Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DXT790AP5-13	DXT790A	13 16		5,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information



DXT790A = Product Type Marking Code I = Manufacturers' Code Marking K = Factory Designator YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 09 for 2009) WW = Week code (01 to 53)





DXT790AP5

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-50	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-6	V
Continuous Collector Current	lc	-3	A
Peak Pulse Current	I _{CM}	-6	A
Base Current	l _Β	-0.5	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Note 5)		3.2	W	
Power Dissipation	(Note 6)	P_{D}	1.7		
	(Note 7)		0.74		
	(Note 5)		39		
Thermal Resistance, Junction to Ambient Air	(Note 6)	$R_{ hetaJA}$	75	°C/W	
	(Note 7)	*	169		
Thermal Resistance, Junction to Lead	(Note 8)	$R_{ hetaJL}$	8.9	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

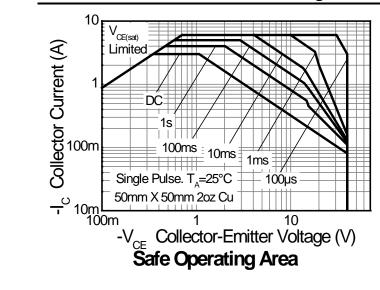
Notes:

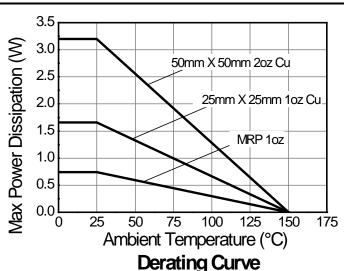
- 5. For a device mounted with the exposed collector pad on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
 6. Same as note (5), except the device is mounted on 25mm x 25mm 1oz copper.
 7. Same as note (5), except the device is mounted on minimum recommended pad (MRP) layout 1oz copper.

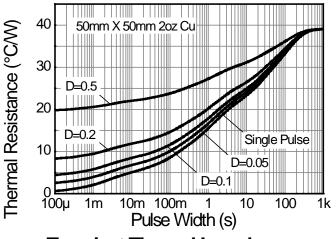
- 8. Thermal resistance from junction to solder-point (on the exposed collector pad).

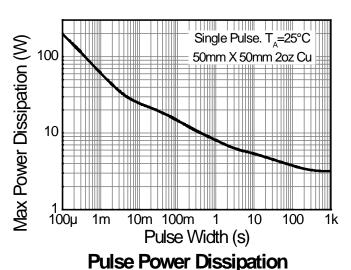


Thermal Characteristics and Derating Information

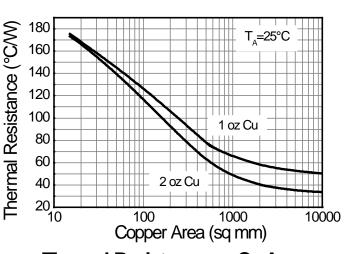








Transient Thermal Impedance



4 T_A=25°C 2 2 oz Cu 1 oz Cu 1 oz Cu 10 100 1000 10000 Copper Area (sq mm)

Thermal Resistance vs. Cu Area

Power Rating vs. Cu Area

Power Rating (W)



DXT790AP5

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

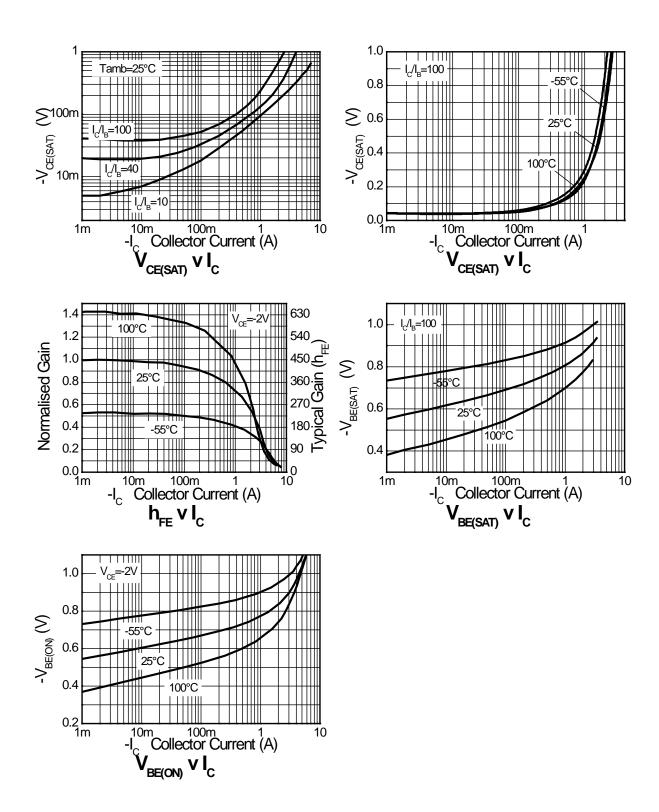
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS	OFF CHARACTERISTICS					
Collector-Base Breakdown Voltage	BV _{CBO}	-50	_	_	V	$I_C = -100\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 8)	BV _{CEO}	-40	_	_	V	$I_C = -10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	-6	_	_	V	$I_E = -100\mu A, I_C = 0$
Collector Cutoff Current	I _{CBO}	_	_	-20	nA	$V_{CB} = -30V, I_{E} = 0$
Collector Cutoff Current	Ices	_	_	-20	nA	$V_{CB} = -30V, V_{BE} = 0$
Emitter Cutoff Current	I _{EBO}	_	_	-20	nA	V _{EB} = -4V, I _C = 0
ON CHARACTERISTICS (Note 8)						
			_	-170		$I_C = -0.5A$, $I_B = -5mA$
Collector-Emitter Saturation Voltage	.,	_		-350	mV	$I_C = -1A$, $I_B = -10mA$
Conector-Entitle Saturation Voltage	V _{CE(sat)}	_	_	-450	IIIV	$I_C = -2A$, $I_B = -50mA$
			_	-450		$I_C = -3A$, $I_B = -300mA$
Base-Emitter Saturation Voltage	V _{BE(sat)}			-1.15	V	$I_C = -3A$, $I_B = -300mA$
Base-Emitter Turn-On Voltage	V _{BE(on)}		_	-1.0	V	$I_C = -3A$, $V_{CE} = -2V$
		300	_	800		$I_C = -10 \text{mA}, V_{CE} = -2 \text{V}$
		250	_	_	1	$I_C = -500 \text{mA}, V_{CE} = -2 \text{V}$
DC Current Gain	h _{FE}	200	_	_	_	$I_C = -1A$, $V_{CE} = -2V$
		150	_	_		$I_C = -2A$, $V_{CE} = -2V$
		80	_	_		$I_{C} = -3A$, $V_{CE} = -2V$
AC CHARACTERISTICS						
Transition Frequency	f _T	100	_	_	MHz	$I_{C} = -50 \text{mA}, V_{CE} = -5 \text{V},$ f = 50MHz
Output Capacitance	Cobo		24		pF	V _{CB} = -10V, f = 1MHz
Switching Times	t _{on}	_	35		ns	$I_C = -500 \text{mA}, V_{CC} = -10 \text{V},$
Owntoning rimes	t _{off}	_	600	_	ns	$I_{B1} = -I_{B2} = -50 \text{mA}$

Notes: 8. Measured under pulsed conditions. Pulse width• 300µs. Duty cycle• 2%.





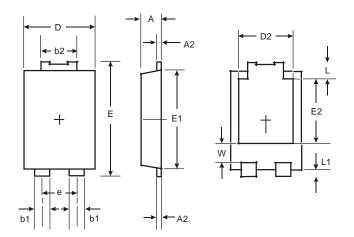
Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)





Package Outline Dimensions

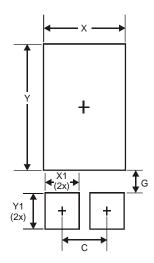
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI5				
Dim	Min	Max		
Α	1.05	1.15		
A2	0.33	0.43		
b1	0.80	0.99		
b2	1.70	1.88		
D	3.90	4.05		
D2	3.054 Typ			
Е	6.40	6.60		
е	1.84	Тур		
E1	5.30	5.45		
E2	3.549 Typ			
L	0.75	0.95		
L1	0.50	0.65		
W	1.10	1.41		
All Dimensions in mm				

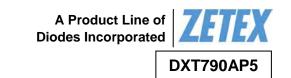
Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Y	4.860
Y1	1.400





IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2013, Diodes Incorporated

www.diodes.com